

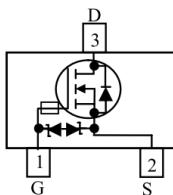
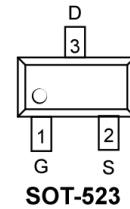
WNM3019

[Http://www.sh-willsemi.com](http://www.sh-willsemi.com)

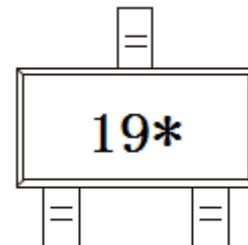
Small Signal N-Channel, 30V, 0.2A, MOSFET

V_{DS} (V)	Typical R_{DS(on)} (Ω)
30	1.2@ V _{GS} =10V
	1.4@ V _{GS} =4.5V
	1.9@ V _{GS} =2.5V
ESD Rating: 2000V HBM	

Top



Pin configuration (Top view)



19 = Device Code

* = Month (A~Z)

Marking

Features

- Trench Technology
- Supper high density cell design
- Excellent ON resistance for higher DC current
- HBM ESD protection >2 kV
- Small package SOT-523

Order information

Device	Package	Shipping
WMN3019-3/TR	SOT-523	3000/Reel&Tape

Applications

- Driver: Relay, Solenoid, Lamps,Hammers etc.
- Power supply converters circuit
- Load/Power Switching for potable device

Absolute Maximum ratings

Parameter	Symbol	10 S	Steady State	Unit
Drain-Source Voltage	V _{DS}	30		V
Gate-Source Voltage	V _{GS}	±20		
Continuous Drain Current ^{a d}	T _A =25°C	I _D	0.25	A
	T _A =70°C		0.20	
Maximum Power Dissipation ^{a d}	T _A =25°C	P _D	0.37	W
	T _A =70°C		0.24	
Continuous Drain Current ^{b d}	T _A =25°C	I _D	0.22	A
	T _A =70°C		0.17	
Maximum Power Dissipation ^{b d}	T _A =25°C	P _D	0.28	W
	T _A =70°C		0.18	
Pulsed Drain Current ^c	I _{DM}		1.0	A
Operating Junction Temperature	T _J		-55 to 150	°C
Lead Temperature	T _L		260	°C
Storage Temperature Range	T _{stg}		-55 to 150	°C

Thermal resistance ratings

Parameter	Symbol	Typical	Maximum	Unit
Junction-to-Ambient Thermal Resistance ^a	t ≤ 10 s	R _{θJA}	285	335
	Steady State		340	
Junction-to-Ambient Thermal Resistance ^b	t ≤ 10 s	R _{θJA}	385	450
	Steady State		455	
Junction-to-Case Thermal Resistance	R _{θJC}	260	300	

a Surface mounted on FR-4 Board using 1 square inch pad size, 1oz copper

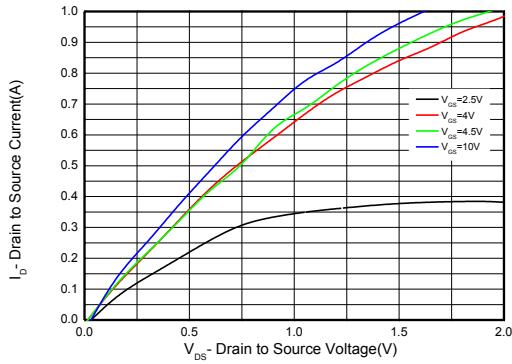
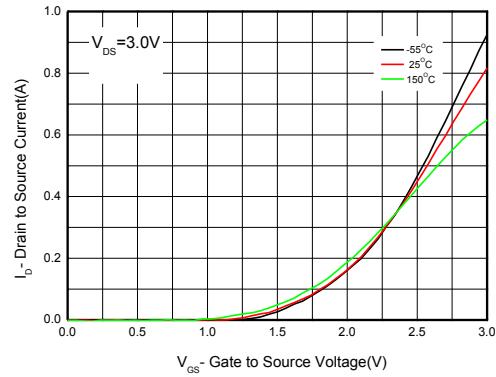
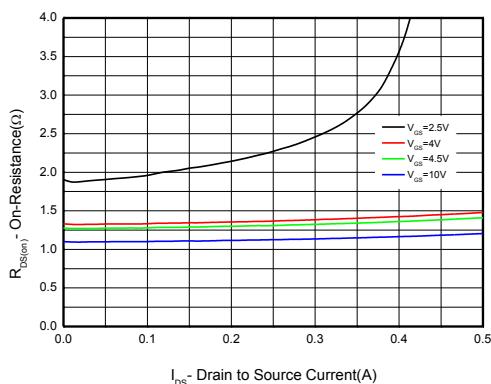
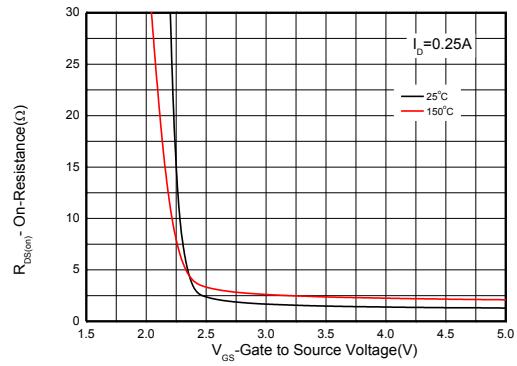
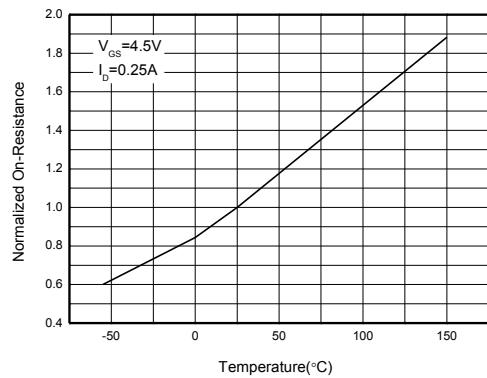
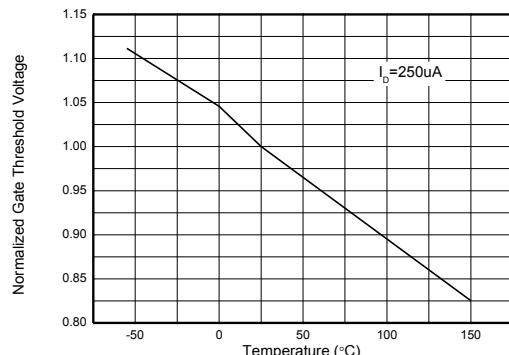
b Surface mounted on FR-4 board using minimum pad size, 1oz copper

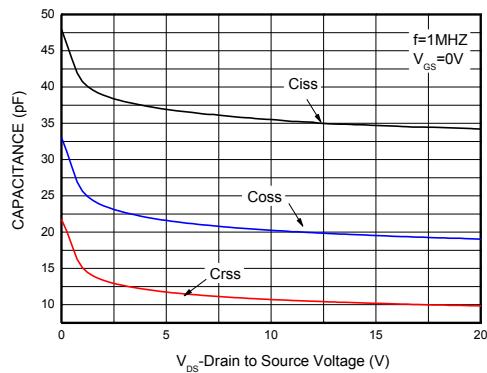
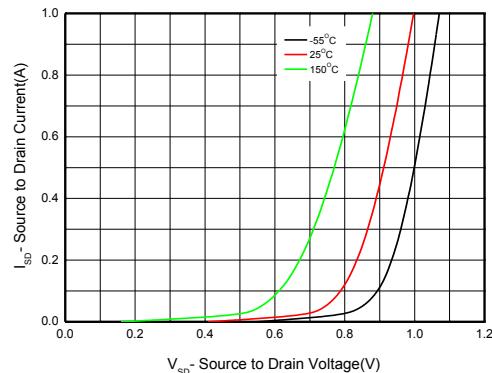
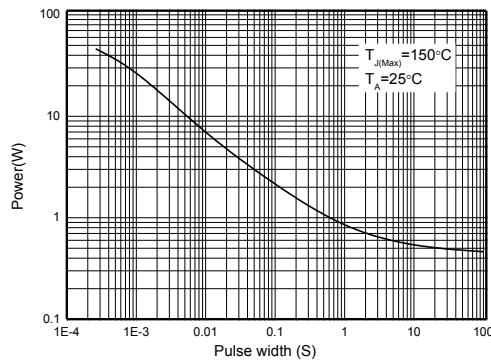
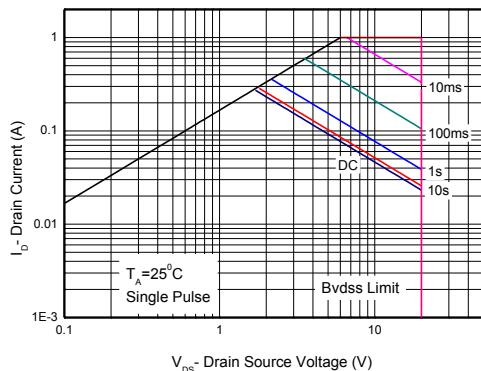
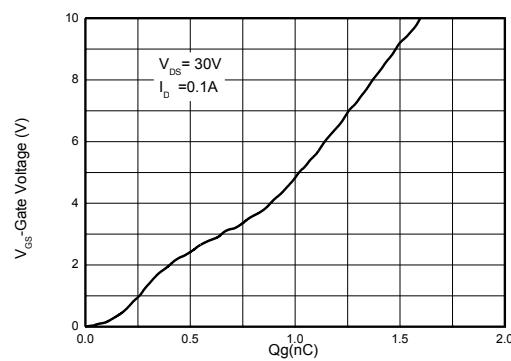
c Pulse width<380μs, Duty Cycle<2%

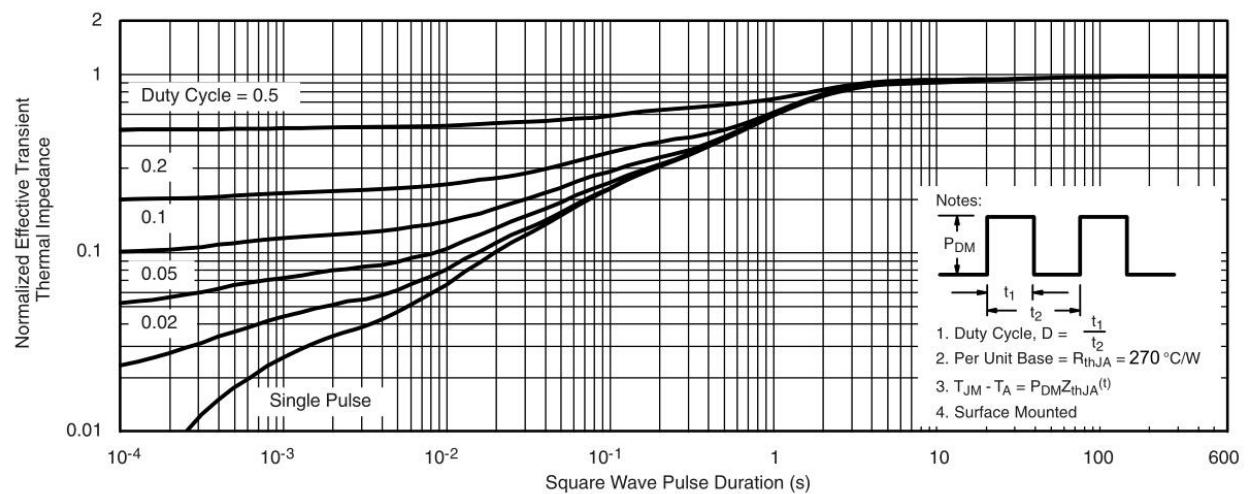
d Maximum junction temperature T_J=150°C.

Electronics Characteristics (Ta=25°C, unless otherwise noted)

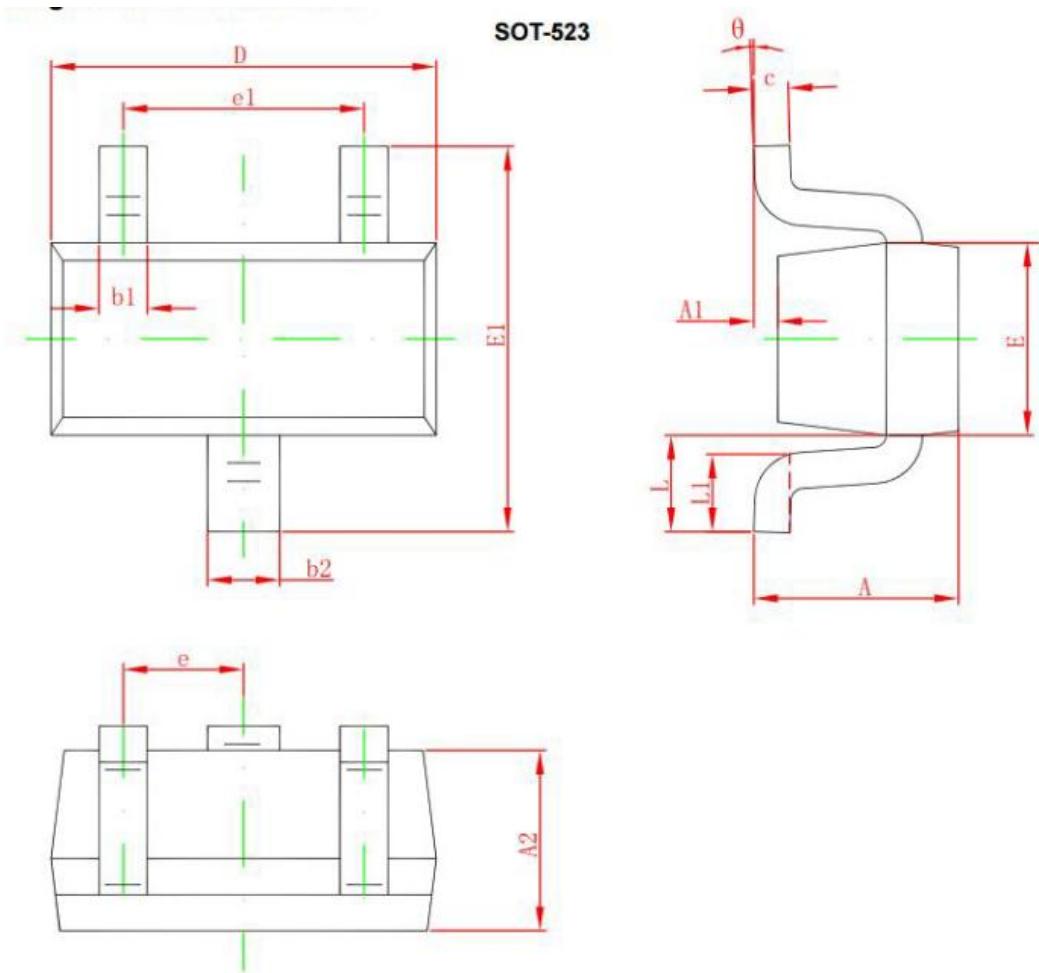
Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Voltage	BV _{DSS}	V _{GS} = 0V, I _D = 250uA	30			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 24V, V _{GS} = 0V			1	uA
Gate-to-source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = ±20V			±5	uA
ON CHARACTERISTICS						
Gate Threshold Voltage	V _{GS(TH)}	V _{GS} = V _{DS} , I _D = 250uA	0.8	1.0	1.5	V
Drain-to-source On-resistance ^{b, c}	R _{DS(on)}	V _{GS} = 10V, I _D = 0.45A		1.2	3	Ω
		V _{GS} = 4.5V, I _D = 0.25A		1.3	4	
		V _{GS} = 4.0V, I _D = 0.25A		1.4	4	
		V _{GS} = 2.5V, I _D = 0.01A		1.9	6	
Forward Trans conductance	g _{fs}	V _{DS} = 15V, I _D = 0.1A		0.5		S
CAPACITANCES, CHARGES						
Input Capacitance	C _{ISS}	V _{GS} = 0 V, F = 1.0 MHz, V _{DS} = 5 V		36		pF
Output Capacitance	C _{OSS}			22		
Reverse Transfer Capacitance	C _{RSS}			12		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DD} = 30 V, I _D = 0.1 A		1.6		nC
Threshold Gate Charge	Q _{G(TH)}			0.25		
Gate-to-Source Charge	Q _{GS}			0.4		
Gate-to-Drain Charge	Q _{GD}			0.45		
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	td(ON)	V _{GS} = 5 V, V _{DD} = 5 V, R _L =500 Ω, R _G =10 Ω, I _D = 10m A		8.6		ns
Rise Time	tr			4		
Turn-Off Delay Time	td(OFF)			23.8		
Fall Time	tf			14.2		
BODY DIODE CHARACTERISTICS						
Forward Voltage	V _{SD}	V _{GS} = 0 V, I _S = 0.25A		0.8	1.5	V

Typical Characteristics (Ta=25°C, unless otherwise noted)

Output characteristics

Transfer characteristics

On-Resistance vs. Drain current

On-Resistance vs. Gate-to-Source voltage

On-Resistance vs. Junction temperature

Threshold voltage vs. Temperature


Capacitance

Body diode forward voltage

Single pulse power

Safe operating power

Gate charge Characteristics



Transient thermal response (Junction-to-Ambient)

Package outline dimensions


Symbol	Dimension in Millimeters	
	Min.	Max.
A	0.700	0.900
A1	0.000	0.100
A2	0.700	0.800
b1	0.150	0.250
b2	0.250	0.350
c	0.100	0.200
D	1.500	1.700
E	0.700	0.900
E1	1.450	1.750
e	0.500 Typ.	
e1	0.900	1.100
L	0.400 Ref.	
L1	0.17 Ref.	
θ	0°	8°